

Film Capacitors

Metallized Polyester Film Capacitors (MKT)

 Series/Type:
 B32572, B32573

 Date:
 June 2018

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Metallized polyester film capacitors (MKT)

Ignition (stacked) SilverCap[™]

L

Dimensional drawing

Cut

surfaces

Typical applications

- Ignition for gas, engines, generators
- Energy storage

Climatic

- Max. operating temperature: 125 °C
- Climatic category (IEC 60068-1:2013): 55/125/56

Features

- Special dimensions available on request
- High pulse strength
- RoHS-compatible

Construction

- Dielectric: polyethylene terephthalate (polyester, PET)
- Stacked-film technology
- Uncoated

Terminals

Parallel wire leads, lead-free tinned

Marking

Rated capacitance (coded), rated DC voltage

Delivery mode

Bulk (untaped)

Notes on mounting

When mounting these capacitors, take into account creepage distances and clearances to adjacent live parts. The insulating strength of the cut surfaces to other live parts of the circuit is 1.5 times the capacitors rated DC voltage, but is always at least 300 V DC.

Dimensions in mm

е

Lead spacing	Lead diameter	Туре
<i>e</i> ±0.4	$d_1 \pm 0.05$	
15.0	0.8	B32572
22.5	0.8	B32573

W

ц С

ød₁

KMK0827-Y-E



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Overview of available types

Lead spacing	15.0 mm	22.5 mm
Туре	B32572	B32573
Page	4	5
V _R (V DC)	250	250
V _{RMS} (V AC)	160	160
C _R (μF)		
0.68		
1.0		
1.5		
2.2		





Ordering codes and packing units (lead spacing 15 mm)

V _R	V _{RMS}	C _R	Max. dimensions	Ordering code	Untaped
	f ≤60 Hz		$w \times h \times l$	(composition see below)	
V DC	V AC	μF	mm		pcs./MOQ
250	160	0.68	7.0 imes 11.0 imes 16.5	B32572A3684+000	1800
		1.0	9.1 imes 11.7 imes 16.5	B32572A3105+000	1200
		1.5	$11.5\times13.5\times16.5$	B32572A3155+000	800
		2.2	$11.5\times19.8\times16.5$	B32572A3225+000	600

MOQ = Minimum Order Quantity, consisting of 4 packing units.

Further E series and intermediate capacitance values on request.

Special dimensions available on request.

For corresponding design rules, refer to chapter "General technical information", section 1.3.2.

Composition of ordering code

+ = Capacitance tolerance code:

 $M = \pm 20\%$ $K = \pm 10\%$ $J = \pm 5\%$



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MKT → 22.5 ◄

Ordering codes and packing units (lead spacing 22.5 mm)

V _R	V _{RMS}	C _R	Max. dimensions	Ordering code	Untaped
	f ≤60 Hz		$w \times h \times l$	(composition see below)	
V DC	V AC	μF	mm		pcs./MOQ
250	160	0.68	$5.6 \times 9.2 \times 24.0$	B32573A3684+000	4720
		1.0	6.4 imes 11.8 imes 24.0	B32573A3105+000	4200
		1.5	$7.6 \times 14.3 \times 24.0$	B32573A3155+000	3720
		2.2	$8.9 \times 17.4 \times 24.0$	B32573A3225+000	2240

MOQ = Minimum Order Quantity, consisting of 4 packing units.

Further E series and intermediate capacitance values on request.

Special dimensions available on request.

For corresponding design rules, refer to chapter "General technical information", section 1.3.2.

Composition of ordering code

+ = Capacitance tolerance code:

 $M = \pm 20\%$ $K = \pm 10\%$ $J = \pm 5\%$



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Technical data

Reference standard: IEC 60384-2:2005. All data given at T = 20 $^{\circ}$ C, unless otherwise specified.

		,	
Operating temperature range	Max. operating temperature T _{op,max} +125 °C		
	Upper category temperature T _{max}		+125 °C
	Lower categ	ory temperature T _{min}	−55 °C
	Rated tempe	erature T _R	+85 °C
Dissipation factor $tan \delta (in 10^{-3})$	at	$C_R \le 1 \ \mu F$	C _R > 1 μF
at 20 $^{\circ}$ C (upper limit values)	1 kHz	8	10
	10 kHz	15	-
Time constant $\tau = C_R \cdot R_{ins}$	2500 s		
at 20 °C, rel. humidity \leq 65%			
(minimum as-delivered values)			
DC test voltage	1.6 · V _R , 2 s		
Category voltage V _c	T _{op} (°C)	DC voltage derating	AC voltage derating
(continuous operation with	$T_{op} \le 85$	$V_{\rm C} = V_{\rm R}$	$V_{C,RMS} = V_{RMS}$
V_{DC} or V_{AC} at f \leq 60 Hz)	85 <t<sub>op≤125</t<sub>	$V_{\rm C} = V_{\rm R} \cdot (165 - T_{\rm op})/80$	$V_{C,RMS} = V_{RMS} \cdot (165 - T_{op})/80$
Max. charging voltage C_{ch}	$1.2 \cdot V_R$ for \leq	≦1s	
Reliability:			
Failure rate λ	2 fit (≤ 2 · 10	^{-9/} h) at 0.5 · V _R , 40 °C	
Service life t _{SL}	100 000 h at	1.0 · V _R , 85 °C	
	For conversi	on to other operating co	nditions and temperatures,
	refer to chap	ter "Quality, 2 Reliability	/".
Failure criteria:			
Total failure	Short circuit	or open circuit	
Failure due to variation	Capacitance	change $ \Delta C/C $	> 10%
of parameters	Dissipation fa	actor tan δ	> 2 \cdot upper limit value
	Time consta	nt $\tau = C_R \cdot R_{ins}$	< 50 s



MKT

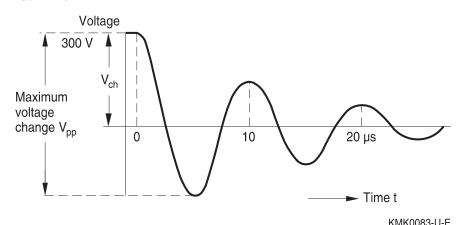
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Pulse handling capability

The capacitors are especially manufactured and tested to suit their intended applications.

Typical permissible load:

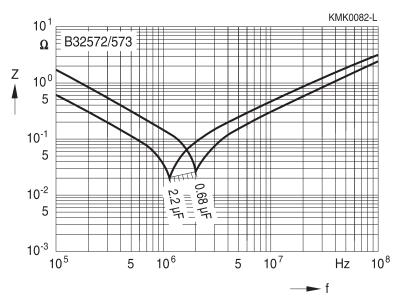


KMK0083-0-E		
Lead spacing		15 and 22.5 mm
Max. rate of voltage rise V_{pp}/τ	(at $V_{pp} = 500 \text{ V}$)	200 V/μs
Pulse characteristic k ₀	(at $V_{pp} \le 500 \text{ V}$)	200 000 V²/µs
Max. charging voltage V_{ch}	(≤1 s)	300 V DC
Max. voltage change V_{pp}	(at f = 100 kHz)	500 V

Unlimited number of pulses permitted.

Impedance Z versus frequency f

(typical values)





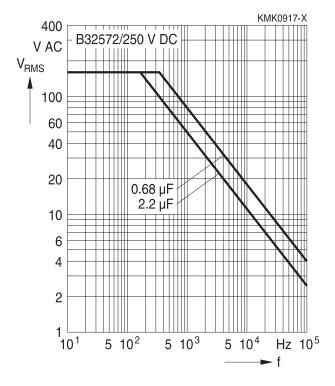


Permissible AC voltage V_{RMS} versus frequency f (for sinusoidal waveforms, T_A \leq 55 °C)

For $T_A > 55 \,^{\circ}C$, please refer to "General technical information", section 3.2.3.

Lead spacing 15 mm









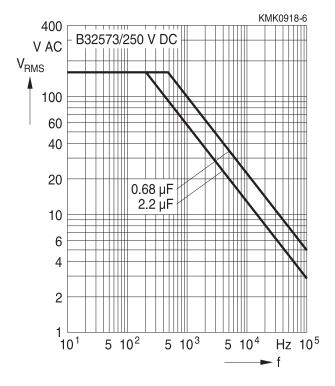


Permissible AC voltage V_{RMS} versus frequency f (for sinusoidal waveforms, T_A \leq 55 °C)

For $T_A > 55 \,^{\circ}C$, please refer to "General technical information", section 3.2.3.

Lead spacing 22.5 mm

250 V DC/160 V AC





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Testing and Standards

Test	Reference	Conditions of test		Performance requirements
Electrical parameters	IEC 60384-2:2005			Within specified limits
Robust- ness of termina- tions	IEC 60068-2-21:2006		t Ua1) Tensile force 0 N	No visible damage Capacitance and tan δ within specified limits
Resistance to soldering heat	IEC 60068-2-20:2008, test Tb, method 1A	Solder bath tempera immersion for 4 seconds (lead space 10 seconds (lead space)	cing ≤10mm)	$\begin{split} &\Delta C/C_0 \leq & 2\% \\ & \Delta \tan \delta \leq & 0.003 \text{ for } C \leq & 1 \ \mu F \\ & \Delta \tan \delta \leq & 0.002 \text{ for } C > & 1 \ \mu F \end{split}$
Rapid change of tempera- ture	IEC 60384-2:2005	T_A = lower category temperature T_B = upper category temperature Five cycles, duration t = 30 min.		$\begin{split} &\Delta C/C_0 \leq \!$
Vibration	IEC 60384-2:2005	Test Fc: vibration sinusoidal Displacement: 0.75 mm Accleration: 98 m/s ² Frequency: 10 Hz 500 Hz Test duration: 3 orthogonal axes, 2 hours each axe		No visible damage
Bump	IEC 60384-2:2005	Test Eb: Total 4000 bumps with 390 m/s ² mounted on PCB Duration: 6 ms		$\begin{array}{l} \Delta C/C_0 \leq \!$
Climatic sequence	IEC 60384-2:2005	Dry heat Tb / 16 h Damp heat cyclic, 1 st cycle +55 °C / 24 h / 95% 100% RH Cold Ta / 2 h Damp heat cyclic, 5 cycles +55 °C / 24 h / 95% 100% RH		$\begin{array}{l} \Delta C/C_0 \leq 5\% \\ \Delta \tan \delta \leq 0.005 \text{ for } C \leq 1 \ \mu F \\ \Delta \tan \delta \leq 0.003 \text{ for } C > 1 \ \mu F \\ R_{\text{ins}} \geq 50\% \text{ of initial limit} \end{array}$
Damp heat, steady state	IEC 60384-2:2005	Test Ca 40 °C / 93% RH / 56	days	No visible damage $ \Delta C/C_0 \leq 5\%$ $ \Delta \tan \delta \leq 0.005$ $R_{ins} \geq 50\%$ of initial limit



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Test	Reference	Conditions of test	Performance requirements
Endurance A	IEC 60384-2:2005	85 °C / 1.25 V _R / 2000 hours	$\label{eq:linear_state} \begin{array}{l} \text{No visible damage} \\ \Delta C/C_0 \leq 5\% \\ \Delta \tan \delta \leq 0.003 \text{ for } C \leq 1\mu\text{F} \\ \Delta \tan \delta \leq 0.002 \text{ for } C > 1\mu\text{F} \\ \text{R}_{\text{ins}} \geq 50\% \text{ of initial limit} \end{array}$
Endurance B	IEC 60384-2:2005	125 °C / 1.25 V _c / 2000 hours	$eq:linear_line$

Mounting guidelines

1 Soldering

1.1 Solderability of leads

The solderability of terminal leads is tested to IEC 60068-2-20, test Ta, method 1.

Before a solderability test is carried out, terminals are subjected to accelerated ageing (to IEC 60068-2-2, test Ba: 4 h exposure to dry heat at 155 °C). Since the ageing temperature is far higher than the upper category temperature of the capacitors, the terminal wires should be cut off from the capacitor before the ageing procedure to prevent the solderability being impaired by the products of any capacitor decomposition that might occur.

Solder bath temperature	235 ±5 °C
Soldering time	2.0 ±0.5 s
Immersion depth	2.0 + 0/-0.5 mm from capacitor body or seating plane
Evaluation criteria:	
Visual inspection	Wetting of wire surface by new solder ≥90%, free-flowing solder





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1.2 Resistance to soldering heat

Resistance to soldering heat is tested to IEC 60068-2-20, test Tb, method 1. Conditions:

Series	Solder bath temperature	Soldering time
MKT boxed (except 2.5 × 6.5 × 7.2 mm) coated uncoated (lead spacing >10 mm) MFP MKP (lead spacing >7.5 mm)	260 ±5 °C	10 ±1 s
MKP (lead spacing >7.5 mm) MKT boxed (case $2.5 \times 6.5 \times 7.2$ mm)	-	<u> </u>
MKP (lead spacing \leq 7.5 mm)		5±1 s <4 s
MKF (lead spacing ≤7.5 mm) MKT uncoated (lead spacing ≤10 mm) insulated (B32559)		<pre><4 s recommended soldering profile for MKT uncoated (lead spacing ≤ 10 mm) and insulated (B32559)</pre>
300 KMK1242-V	· ·	
$^{\circ}C$ 250 200 150 100 50 0 0 50 100 150 200 s 25	50	
Immersion depth	$2.0 \pm 0/-0.5$ mm from car	acitor body or seating plane
Shield	2.0 + 0/-0.5 mm from capacitor body or seating plane Heat-absorbing board, (1.5 ±0.5) mm thick, between	
	capacitor body and liquid	
Evaluation criteria:		
Visual inspection	No visible damage	
$\Delta C/C_0$	2% for MKT/MKP/MFP 5% for EMI suppression of	capacitors
tan δ	As specified in sectional s	•

Please read *Cautions and warnings* and *Important notes* at the end of this document.



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1.3 General notes on soldering

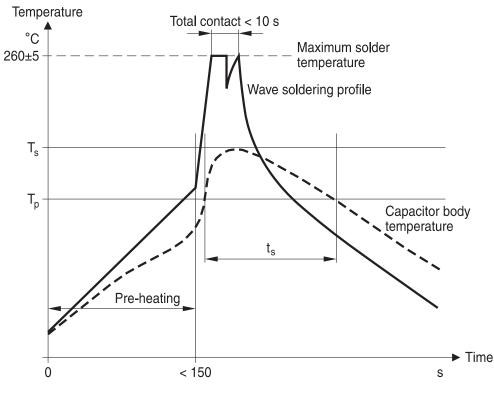
Permissible heat exposure loads on film capacitors are primarily characterized by the upper category temperature T_{max} . Long exposure to temperatures above this type-related temperature limit can lead to changes in the plastic dielectric and thus change irreversibly a capacitor's electrical characteristics. For short exposures (as in practical soldering processes) the heat load (and thus the possible effects on a capacitor) will also depend on other factors like:

- Pre-heating temperature and time
- Forced cooling immediately after soldering
- Terminal characteristics:
- diameter, length, thermal resistance, special configurations (e.g. crimping)
- Height of capacitor above solder bath
- Shadowing by neighboring components
- Additional heating due to heat dissipation by neighboring components
- Use of solder-resist coatings

The overheating associated with some of these factors can usually be reduced by suitable countermeasures. For example, if a pre-heating step cannot be avoided, an additional or reinforced cooling process may possibly have to be included.

Recommendations

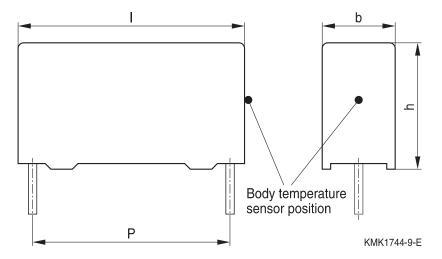
As a reference, the recommended wave soldering profile for our film capacitors is as follows:



 $T_{s}: Capacitor body maximum temperature at wave soldering \\T_{p}: Capacitor body maximum temperature at pre-heating \\KMK1745-A-E$







Body temperature should follow the description below:

- MKP capacitor During pre-heating: T_p ≤110 °C During soldering: T_s ≤120 °C, t_s ≤45 s
- MKT capacitor During pre-heating: T_p ≤125 °C During soldering: T_s ≤160 °C, t_s ≤45 s

When SMD components are used together with leaded ones, the film capacitors should not pass into the SMD adhesive curing oven. The leaded components should be assembled after the SMD curing step.

Leaded film capacitors are not suitable for reflow soldering.

In order to ensure proper conditions for manual or selective soldering, the body temperature of the capacitor (T_s) must be \leq 120 °C.

One recommended condition for manual soldering is that the tip of the soldering iron should be <360 °C and the soldering contact time should be no longer than 3 seconds.

For uncoated MKT capacitors with lead spacings \leq 10 mm (B32560/B32561) the following measures are recommended:

- pre-heating to not more than 110 °C in the preheater phase
- rapid cooling after soldering

Please refer to our Film Capacitors Data Book in case more details are needed.



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Cautions and warnings

- Do not exceed the upper category temperature (UCT).
- Do not apply any mechanical stress to the capacitor terminals.
- Avoid any compressive, tensile or flexural stress.
- Do not move the capacitor after it has been soldered to the PC board.
- Do not pick up the PC board by the soldered capacitor.
- Do not place the capacitor on a PC board whose PTH hole spacing differs from the specified lead spacing.
- Do not exceed the specified time or temperature limits during soldering.
- Avoid external energy inputs, such as fire or electricity.
- Avoid overload of the capacitors.
- Consult us if application is with severe temperature and humidity condition.
- There are no serviceable or repairable parts inside the capacitor. Opening the capacitor or any attempts to open or repair the capacitor will void the warranty and liability of TDK Electronics.
- Please note that the standards referred to in this publication may have been revised in the meantime.

The table below summarizes the safety instructions that must always be observed. A detailed description can be found in the relevant sections of the chapters "General technical information" and "Mounting guidelines".

Торіс	Safety information	Reference chapter "General technical information"
Storage conditions	Make sure that capacitors are stored within the specified range of time, temperature and humidity conditions.	4.5 "Storage conditions"
Flammability	Avoid external energy, such as fire or electricity (passive flammability), avoid overload of the capacitors (active flammability) and consider the flammability of materials.	5.3 "Flammability"
Resistance to vibration	Do not exceed the tested ability to withstand vibration. The capacitors are tested to IEC 60068-2-6:2007. TDK Electronics offers film capacitors specially designed for operation under more severe vibration regimes such as those found in automotive applications. Consult our catalog "Film Capacitors for Automotive Electronics".	5.2 "Resistance to vibration"



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Topic	Safety information	Reference chapter "Mounting guidelines"
Soldering	Do not exceed the specified time or temperature limits during soldering.	1 "Soldering"
Cleaning	Use only suitable solvents for cleaning capacitors.	2 "Cleaning"
Embedding of capacitors in finished assemblies	When embedding finished circuit assemblies in plastic resins, chemical and thermal influences must be taken into account. Caution: Consult us first, if you also wish to embed other uncoated component types!	3 "Embedding of capacitors in finished assemblies"

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Data sheet values and results of design tools may deviate as they have not been derived in the same context.

While data sheets show individual parameter statements without considering a possible dependency to other parameters. Tools model a complete given scenario as input and processed inside the tool.

Furthermore as we constantly strive to improve our models, the results of tools can change over time and be a non-binding indication only.



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Symbols and terms

Symbol	English	German
α	Heat transfer coefficient	Wärmeübergangszahl
α_{c}	Temperature coefficient of capacitance	Temperaturkoeffizient der Kapazität
A	Capacitor surface area	Kondensatoroberfläche
β _c	Humidity coefficient of capacitance	Feuchtekoeffizient der Kapazität
С	Capacitance	Kapazität
C _R	Rated capacitance	Nennkapazität
ΔC	Absolute capacitance change	Absolute Kapazitätsänderung
∆C/C	Relative capacitance change (relative deviation of actual value)	Relative Kapazitätsänderung (relative Abweichung vom Ist-Wert)
$\Delta C/C_R$	Capacitance tolerance (relative deviation from rated capacitance)	Kapazitätstoleranz (relative Abweichung vom Nennwert)
dt	Time differential	Differentielle Zeit
Δt	Time interval	Zeitintervall
ΔT	Absolute temperature change (self-heating)	Absolute Temperaturänderung (Selbsterwärmung)
∆tan δ	Absolute change of dissipation factor	Absolute Änderung des Verlustfaktors
ΔV	Absolute voltage change	Absolute Spannungsänderung
dV/dt	Time differential of voltage function (rate of voltage rise)	Differentielle Spannungsänderung (Spannungsflankensteilheit)
$\Delta V / \Delta t$	Voltage change per time interval	Spannungsänderung pro Zeitintervall
E	Activation energy for diffusion	Aktivierungsenergie zur Diffusion
ESL	Self-inductance	Eigeninduktivität
ESR	Equivalent series resistance	Ersatz-Serienwiderstand
f	Frequency	Frequenz
f ₁	Frequency limit for reducing permissible AC voltage due to thermal limits	Grenzfrequenz für thermisch bedingte Reduzierung der zulässigen Wechselspannung
f ₂	Frequency limit for reducing permissible AC voltage due to current limit	Grenzfrequenz für strombedingte Reduzierung der zulässigen Wechselspannung
f _r	Resonant frequency	Resonanzfrequenz
F _D	Thermal acceleration factor for diffusion	Therm. Beschleunigungsfaktor zur Diffusion
F _τ	Derating factor	Deratingfaktor
i	Current (peak)	Stromspitze
l _c	Category current (max. continuous current)	Kategoriestrom (max. Dauerstrom)



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Symbol	English	German
I _{RMS}	(Sinusoidal) alternating current,	(Sinusförmiger) Wechselstrom
	root-mean-square value	
i _z	Capacitance drift	Inkonstanz der Kapazität
k ₀	Pulse characteristic	Impulskennwert
Ls	Series inductance	Serieninduktivität
λ	Failure rate	Ausfallrate
λο	Constant failure rate during useful	Konstante Ausfallrate in der
	service life	Nutzungsphase
$\lambda_{ ext{test}}$	Failure rate, determined by tests	Experimentell ermittelte Ausfallrate
P _{diss}	Dissipated power	Abgegebene Verlustleistung
P _{gen}	Generated power	Erzeugte Verlustleistung
Q	Heat energy	Wärmeenergie
ρ	Density of water vapor in air	Dichte von Wasserdampf in Luft
R	Universal molar constant for gases	Allg. Molarkonstante für Gas
R	Ohmic resistance of discharge circuit	Ohmscher Widerstand des
		Entladekreises
R _i	Internal resistance	Innenwiderstand
R _{ins}	Insulation resistance	Isolationswiderstand
R _P	Parallel resistance	Parallelwiderstand
Rs	Series resistance	Serienwiderstand
S	severity (humidity test)	Schärfegrad (Feuchtetest)
t	Time	Zeit
Т	Temperature	Temperatur
τ	Time constant	Zeitkonstante
tan δ	Dissipation factor	Verlustfaktor
$tan \delta_D$	Dielectric component of dissipation factor	Dielektrischer Anteil des Verlustfaktors
tan δ _P	Parallel component of dissipation factor	Parallelanteil des Verlfustfaktors
tan δ_s	Series component of dissipation factor	Serienanteil des Verlustfaktors
T _A	Temperature of the air surrounding the component	Temperatur der Luft, die das Bauteil umgibt
T _{max}	Upper category temperature	Obere Kategorietemperatur
T _{min}	Lower category temperature	Untere Kategorietemperatur
t _{OL}	Operating life at operating temperature and voltage	Betriebszeit bei Betriebstemperatur und -spannung
T _{op}	Operating temperature, $T_A + \Delta T$	Beriebstemperatur, $T_A + \Delta T$
Τ _{ορ} Τ _R	Rated temperature Rated temperature	Nenntemperatur
T _R T _{ref}	Reference temperature	Referenztemperatur
I _{ref} t _{SL}	Reference service life	Referenz-Lebensdauer



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Symbol	English	German
V _{AC}	AC voltage	Wechselspannung
V _c	Category voltage	Kategoriespannung
V _{C,RMS}	Category AC voltage	(Sinusförmige)
		Kategorie-Wechselspannung
V_{CD}	Corona-discharge onset voltage	Teilentlade-Einsatzspannung
V_{ch}	Charging voltage	Ladespannung
V_{DC}	DC voltage	Gleichspannung
V_{FB}	Fly-back capacitor voltage	Spannung (Flyback)
V _i	Input voltage	Eingangsspannung
V _o	Output voltage	Ausgangssspannung
V_{op}	Operating voltage	Betriebsspannung
V _p	Peak pulse voltage	Impuls-Spitzenspannung
V_{pp}	Peak-to-peak voltage Impedance	Spannungshub
V _R	Rated voltage	Nennspannung
Ŷ _R	Amplitude of rated AC voltage	Amplitude der Nenn-Wechselspannung
V_{RMS}	(Sinusoidal) alternating voltage,	(Sinusförmige) Wechselspannung
	root-mean-square value	
V_{SC}	S-correction voltage	Spannung bei Anwendung "S-correction"
V_{sn}	Snubber capacitor voltage	Spannung bei Anwendung
		"Beschaltung"
Z	Impedance	Scheinwiderstand
е	Lead spacing	Rastermaß



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Important notes

- 7. Our manufacturing sites serving the automotive business apply the IATF 16949 standard. The IATF certifications confirm our compliance with requirements regarding the quality management system in the automotive industry. Referring to customer requirements and customer specific requirements ("CSR") TDK always has and will continue to have the policy of respecting individual agreements. Even if IATF 16949 may appear to support the acceptance of unilateral requirements, we hereby like to emphasize that only requirements mutually agreed upon can and will be implemented in our Quality Management System. For clarification purposes we like to point out that obligations from IATF 16949 shall only become legally binding if individually agreed upon.
- 8. The trade names EPCOS, CarXield, CeraCharge, CeraDiode, CeraLink, CeraPad, CeraPlas, CSMP, CTVS, DeltaCap, DigiSiMic, ExoCore, FilterCap, FormFit, LeaXield, MiniBlue, MiniCell, MKD, MKK, ModCap, MotorCap, PCC, PhaseCap, PhaseCube, PhaseMod, PhiCap, PowerHap, PQSine, PQvar, SIFERRIT, SIFI, SIKOREL, SilverCap, SIMDAD, SiMic, SIMID, SineFormer, SIOV, ThermoFuse, WindCap, XieldCap are trademarks registered or pending in Europe and in other countries. Further information will be found on the Internet at www.tdk-electronics.tdk.com/trademarks.

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